

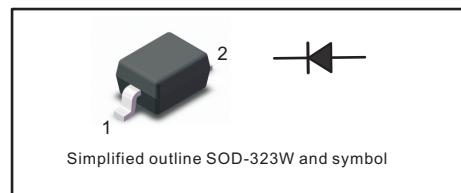


## FEATURES

- For surface mounted applications
- Glass Passivated Chip Junction
- Fast reverse recovery time
- Ideal for automated placement
- Lead free in comply with EU RoHS 2011/65/EU directives

## PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1   | Cathode     |
| 2   | Anode       |



## MECHANICAL DATA

- Case: SOD-323W
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 5.48mg / 0.00019oz

## Absolute Maximum Ratings at 25 °C

| Parameter                                 | Symbols                | T-1N4148WB    | Units |
|---|------------------------|---------------|-------|
| Maximum Repetitive Peak Reverse Voltage   | $V_{RRM}$              | 100           | V     |
| Maximum RMS voltage                       | $V_{RMS}$              | 75            | V     |
| Average Rectified Forward Current         | $I_{F(AV)}$            | 150           | mA    |
| Non-repetitive Peak Forward Surge Current | $I_{FSM}$              | 0.5<br>1<br>4 | A     |
| Total Power Dissipation                   | $P_{tot}$              | 400           | mW    |
| Typical Thermal Resistance (1)            | $R_{θJA}$<br>$R_{θJC}$ | 340<br>120    | °C/W  |
| Operating and Storage Temperature Range   | $T_j, T_{stg}$         | -55 ~ +150    | °C    |

(1) P.C.B. mounted with 5\*5mm copper pad areas.

## Characteristics at $T_a = 25^\circ C$

| Parameter                                     | Symbols     | T-1N4148WB                     | Units |
|---|-------------|--------------------------------|-------|
| Reverse Breakdown Voltage at $I_R=1\mu A$     | $V_{(BR)R}$ | 75                             | V     |
| Maximum Forward Voltage                       | $V_F$       | 0.715<br>0.855<br>1.00<br>1.25 | V     |
| Peak Reverse Current                          | $I_R$       | 0.025<br>1<br>30<br>50         | μA    |
| Typical Junction Capacitance $f=1MHz, V_R=0V$ | $C_J$       | 2                              | pF    |
| Maximum Reverse Recovery Time (2)             | $t_{rr}$    | 4                              | ns    |

(2) Measured with  $I_F=I_R=10mA, I_{RR}=0.1\times I_R, R_L=100Ω$



Fig.1 Power Derating Curve

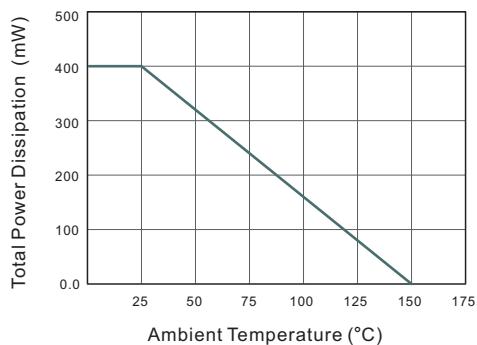


Fig.2 Typical Reverse Characteristics

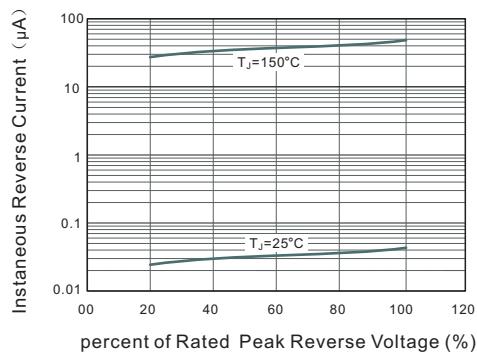


Fig.3 Typical Instantaneous Forward Characteristics

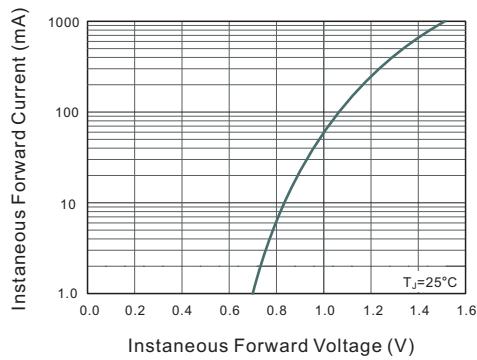
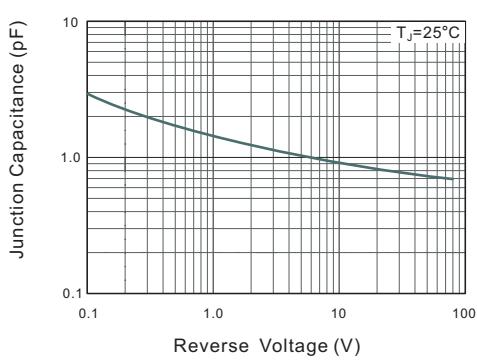


Fig.4 Typical Junction Capacitance

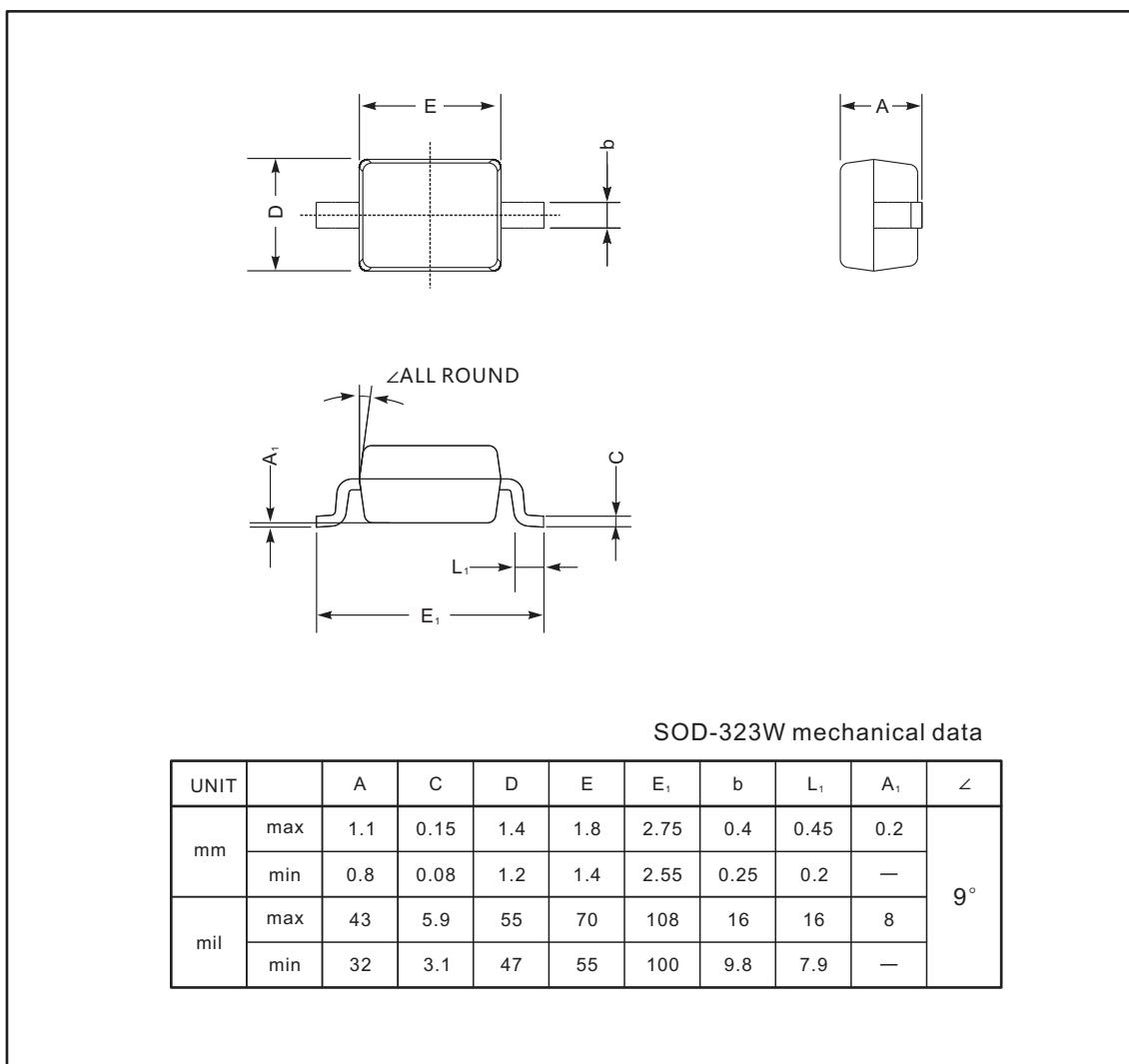




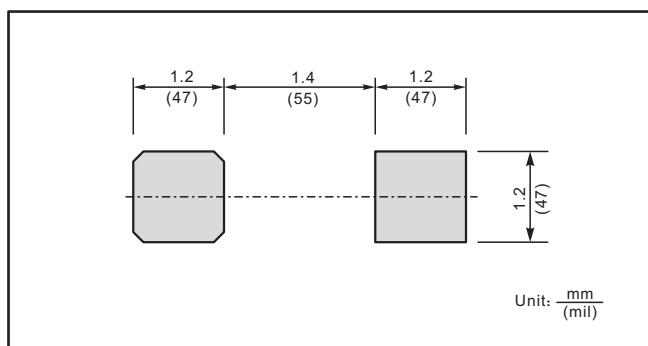
## PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD-323W



The recommended mounting pad size



Marking

| Type number | Marking code |
|-------------|--------------|
| T-1N4148WB  | T4           |